

### KSC2785

# Audio Frequency Amplifier & High Frequency OSC.

- Complement to KSA1175
- Collector-Base Voltage : V<sub>CBO</sub>=60V



### 1.Emitter 2. Collector 3. Base

## **NPN Epitaxial Silicon Transistor**

### **Absolute Maximum Ratings** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	60	V
V <sub>CEO</sub>	Collector-Emitter Voltage	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	5	V
I <sub>C</sub>	Collector Current	150	mA
P <sub>C</sub>	Collector Power Dissipation	250	mW
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C

### **Electrical Characteristics** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> =100μA, I <sub>E</sub> =0	60			V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =0	50			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E=10\mu A, I_C=0$	5			V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB}$ =40V, $I_E$ =0			0.1	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB}=3V$ , $I_{C}=0$			0.1	μΑ
h <sub>FE</sub>	DC Current Gain	$V_{CE}$ =6V, $I_{C}$ =1.0mA	70		700	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> =100mA, I <sub>B</sub> =10mA		0.15	0.3	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> =6V, I <sub>C</sub> =10mA		300		MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> =6V, I <sub>E</sub> =0, f=1MHz		2.5		pF
NF	Noise Figure	$V_{CE}$ =6, $I_{C}$ =0.5mA f=1KHz, $R_{S}$ =500 $\Omega$		4.0		dB

### **h**<sub>FE</sub> Classification

Classification	0	Υ	G	L
h <sub>FE</sub>	70 ~ 140	120 ~ 240	200 ~ 400	350 ~ 700

## **Typical Characteristics**

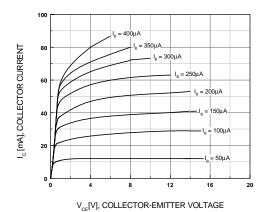


Figure 1. Static Characteristics

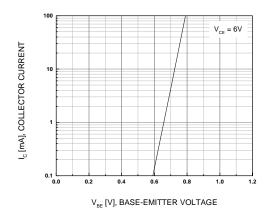


Figure 2. Base-Emitter On Voltage

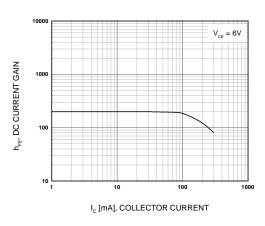


Figure 3. DC Current Gain

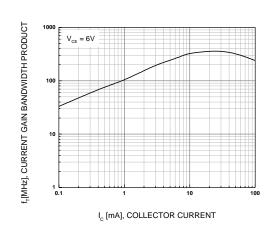


Figure 4. f<sub>T</sub> - I<sub>C</sub>

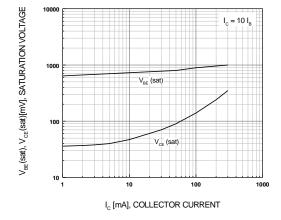


Figure 5. Saturation Voltage

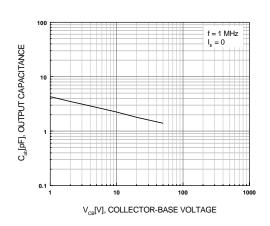
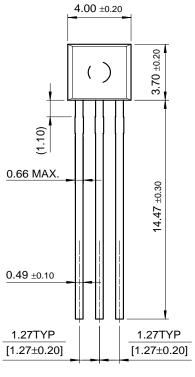


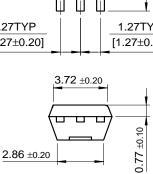
Figure 6. Output Capacitance

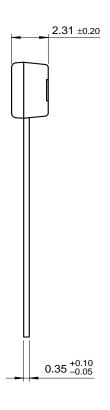
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## **Package Dimensions**

## **TO-92S**







Dimensions in Millimeters

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CROSSVOLT™	FRFET™	MicroPak™	QFET™	SuperSOT™-8
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EcoSPARK™	GTO™	MSX™	QT Optoelectronics™	TinyLogic™
E <sup>2</sup> CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	$I^2C^{TM}$	$OCX^{TM}$	RapidConfigure™	UHC™
Across the board.	. Around the world.™	OCXPro™	RapidConnect™	UltraFET <sup>®</sup>
The Power Franchise™		OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	$VCX^{TM}$
Programmable Ad	ctive Droop™	OPTOPLANAR™	SMART START™	

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